



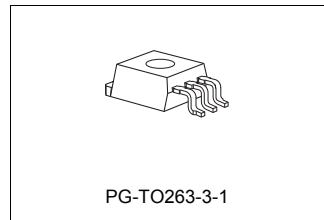
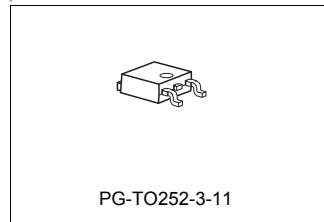
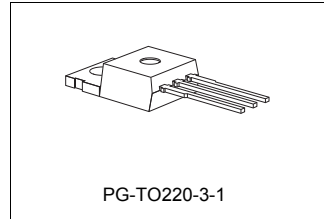
**THE DATASHEET OF  
M29W800DB70N1**





## Features

- Output voltage 5 V, 8.5 V or 10 V
- Output voltage tolerance  $\leq \pm 4\%$
- Current capability 400 mA
- Low-drop voltage
- Very low current consumption
- Short-circuit proof
- Reverse polarity proof
- Suitable for use in automotive electronics
- Green Product (RoHS compliant) version of TLE 4274
- AEC qualified



## Functional Description

The TLE 4274 is a low drop voltage regulator available in a TO220, TO252 and TO263 package. The IC regulates an input voltage up to 40 V to  $V_{Qrated} = 5.0\text{ V (V50)}$ ,  $8.5\text{ V (V85)}$  and  $10\text{ V (V10)}$ . The maximum output current is 400 mA. The IC is short-circuit proof and incorporates temperature protection that disables the IC at overtemperature. A 3.3 V and 2.5 V version is also available. For information about the low output voltage types please refer to the data sheet TLE 4274 / 3.3 V; 2.5 V.

Type	Package
TLE 4274 V10	PG-TO220-3-1 (RoHS compliant)
TLE 4274 V50	PG-TO220-3-1 (RoHS compliant)
TLE 4274 V85	PG-TO220-3-1 (RoHS compliant)
TLE 4274 DV50	PG-TO252-3-11 (RoHS compliant)
TLE 4274 GV10	PG-TO263-3-1 (RoHS compliant)
TLE 4274 GV50	PG-TO263-3-1 (RoHS compliant)
TLE 4274 GV85	PG-TO263-3-1 (RoHS compliant)

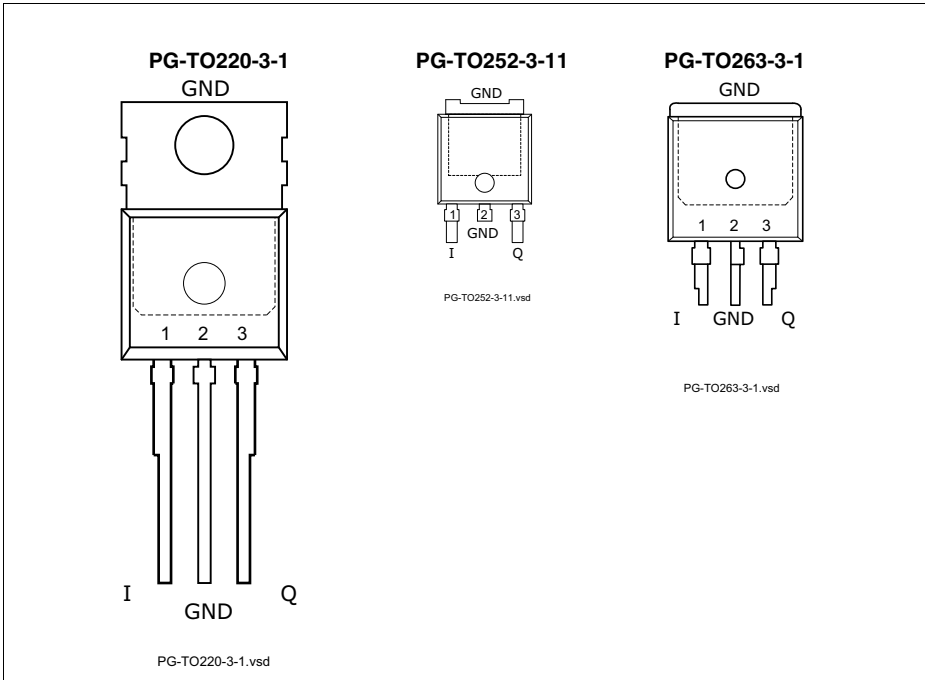
### **Dimensioning Information on External Components**

The input capacitor  $C_1$  is necessary for compensating line influences. Using a resistor of approx.  $1 \Omega$  in series with  $C_1$ , the oscillating of input inductivity and input capacitance can be damped. The output capacitor  $C_Q$  is necessary for the stability of the regulation circuit. Stability is guaranteed at values  $C_Q \geq 22 \mu\text{F}$  and an ESR of  $\leq 3 \Omega$  within the operating temperature range.

### **Circuit Description**

The control amplifier compares a reference voltage to a voltage that is proportional to the output voltage and drives the base of the series transistor via a buffer. Saturation control as a function of the load current prevents any oversaturation of the power element. The IC also includes a number of internal circuits for protection against:

- Overload
- Overtemperature
- Reverse polarity



**Figure 1** Pin Configuration (top view)

**Table 1** Pin Definitions and Functions

Pin No.	Symbol	Function
1	I	<b>Input</b> ; block to ground directly at the IC with a ceramic capacitor.
2	GND	<b>Ground</b>
3	Q	<b>Output</b> ; block to ground with a $\geq 22 \mu\text{F}$ capacitor, $\text{ESR} \leq 3 \Omega$ .
TAB	-	<b>TAB</b> ; connect to heatsink and GND to improve thermal performance



**Table 2 Absolute Maximum Ratings**
 $T_j = -40$  to  $150$  °C

Parameter	Symbol	Limit Values		Unit	Test Condition
		Min.	Max.		
<b>Input</b>					
Voltage	$V_I$	-42	45	V	–
Current	$I_I$	–	–	–	Internally limited
<b>Output</b>					
Voltage	$V_Q$	-1.0	40	V	–
Current	$I_Q$	–	–	–	Internally limited
<b>Ground</b>					
Current	$I_{GND}$	–	100	mA	–
<b>Temperature</b>					
Junction temperature	$T_j$	–	150	°C	–
Storage temperature	$T_{stg}$	-50	150	°C	–

*Note: Maximum ratings are absolute ratings; exceeding any one of these values may cause irreversible damage to the integrated circuit.*

**Table 3 Operating Range**

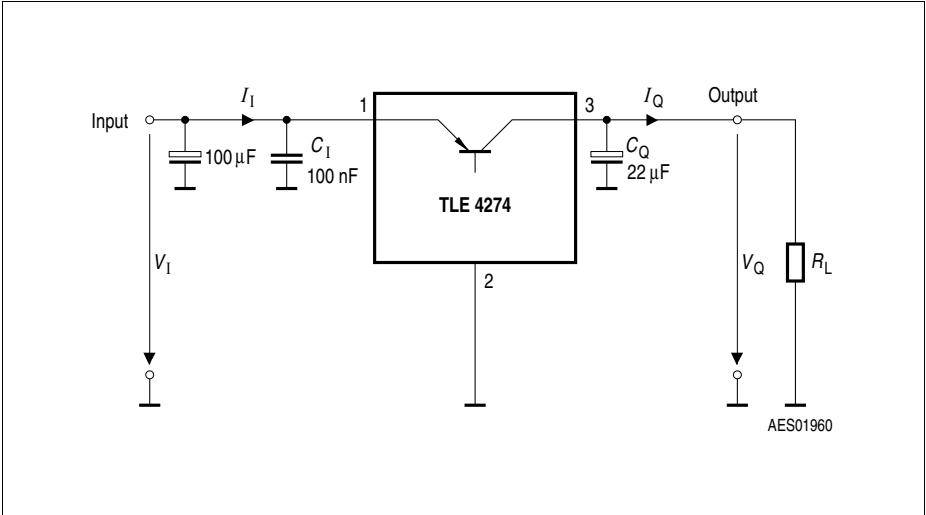
Parameter	Symbol	Limit Values		Unit	Remarks
		Min.	Max.		
Input voltage; V50, DV50, GV50	$V_I$	5.5	40	V	–
Input voltage, V85, GV85	$V_I$	9.0	40	V	–
Input voltage, V10, GV10	$V_I$	10.5	40	V	–
Junction temperature	$T_j$	-40	150	°C	–
<b>Thermal Resistance</b>					
Junction ambient	$R_{thja}$	–	65	K/W	TO220 <sup>1)</sup>
Junction ambient	$R_{thja}$	–	78	K/W	TO252 <sup>1)</sup>
Junction ambient	$R_{thja}$	–	52	K/W	TO263 <sup>1)</sup>
Junction case	$R_{thjc}$	–	4	K/W	–

1) Worst case; regarding peak temperature, zero airflow mounted on PCB  $80 \times 80 \times 1.5$  mm<sup>3</sup>, 300 mm<sup>2</sup> heat sink area.

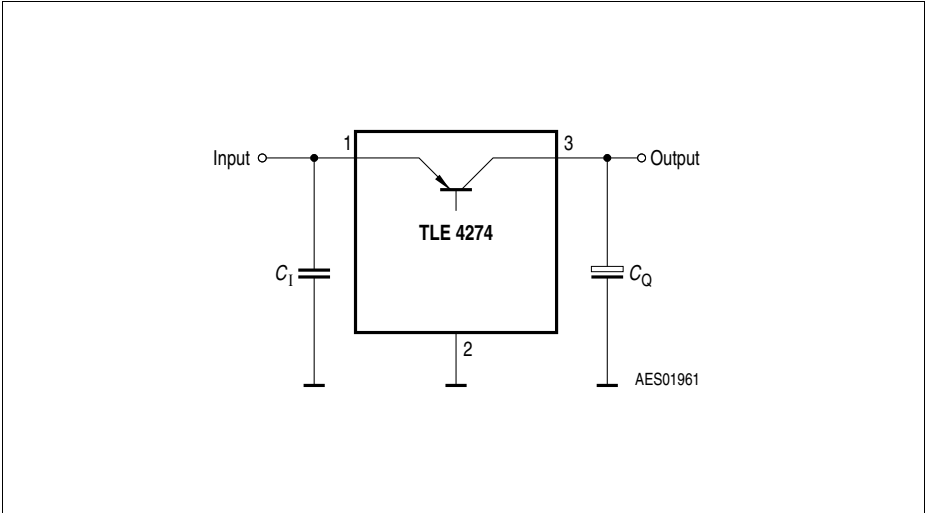
**Table 4 Characteristics**
 $V_I = 13.5 \text{ V}; -40 \text{ }^\circ\text{C} < T_j < 150 \text{ }^\circ\text{C}$  (unless otherwise specified)

Parameter	Symbol	Limit Values			Unit	Measuring Conditions
		Min.	Typ.	Max.		
Output voltage V50-Version	$V_Q$	4.8	5	5.2	V	$5 \text{ mA} < I_Q < 400 \text{ mA}$ $6 \text{ V} < V_I < 28 \text{ V}$
Output voltage V50-Version	$V_Q$	4.8	5	5.2	V	$5 \text{ mA} < I_Q < 200 \text{ mA}$ $6 \text{ V} < V_I < 40 \text{ V}$
Output voltage V85-Version	$V_Q$	8.16	8.5	8.84	V	$5 \text{ mA} < I_Q < 400 \text{ mA}$ $9.5 \text{ V} < V_I < 28 \text{ V}$
Output voltage V85-Version	$V_Q$	8.16	8.5	8.84	V	$5 \text{ mA} < I_Q < 200 \text{ mA}$ $9.5 \text{ V} < V_I < 40 \text{ V}$
Output voltage V10-Version	$V_Q$	9.6	10	10.4	V	$5 \text{ mA} < I_Q < 400 \text{ mA}$ $11 \text{ V} < V_I < 28 \text{ V}$
Output voltage V10-Version	$V_Q$	9.6	10	10.4	V	$5 \text{ mA} < I_Q < 200 \text{ mA}$ $11 \text{ V} < V_I < 40 \text{ V}$
Output current limitation <sup>1)</sup>	$I_Q$	400	600	–	mA	–
Current consumption; $I_q = I_I - I_Q$	$I_q$	–	100	220	$\mu\text{A}$	$I_Q = 1 \text{ mA}$
Current consumption; $I_q = I_I - I_Q$	$I_q$	–	8	15	mA	$I_Q = 250 \text{ mA}$ $I_Q = 400 \text{ mA}$
		–	20	30	mA	
Drop voltage <sup>1)</sup>	$V_{dr}$	–	250	500	mV	$I_Q = 250 \text{ mA}$ $V_{dr} = V_I - V_Q$
Load regulation	$\Delta V_Q$	–	20	50	mV	$I_Q = 5 \text{ mA to } 400 \text{ mA}$
Line regulation	$\Delta V_Q$	–	10	25	mV	$\Delta V_I = 12 \text{ V to } 32 \text{ V}$ $I_Q = 5 \text{ mA}$
Power supply ripple rejection	$PSRR$	–	60	–	dB	$f_r = 100 \text{ Hz};$ $V_r = 0.5 \text{ Vpp}$
Temperature output voltage drift	$dV_Q/dT$	–	0.5	–	mV/K	–

<sup>1)</sup> Measured when the output voltage  $V_Q$  has dropped 100 mV from the nominal value obtained at  $V_I = 13.5 \text{ V}$ .



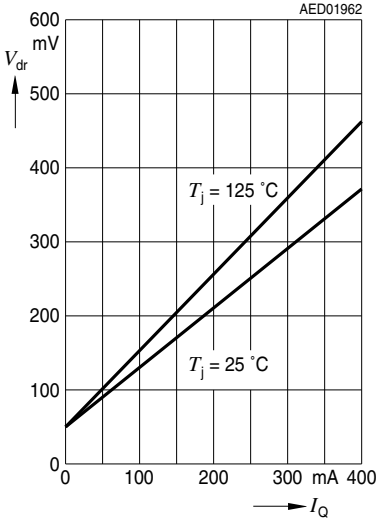
**Figure 3 Measuring Circuit**



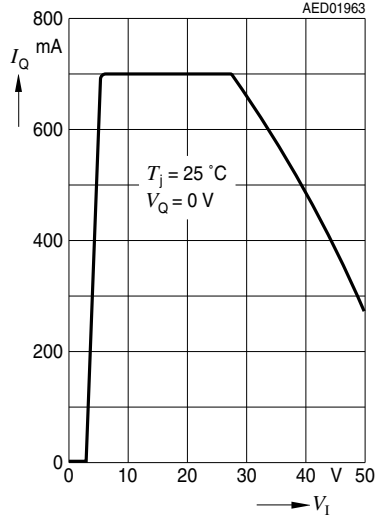
**Figure 4 Application Circuit**

Typical Performance Characteristics (V50, V85 and V10)

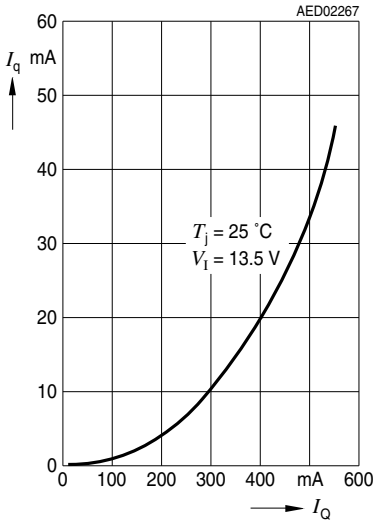
Drop Voltage  $V_{dr}$  versus Output Current  $I_Q$



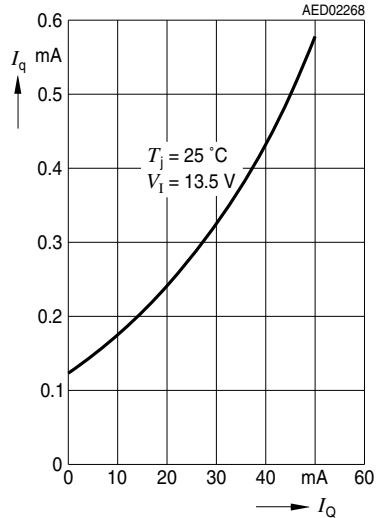
Output Current  $I_Q$  versus Input Voltage  $V_I$



Current Consumption  $I_q$  versus Output Current  $I_Q$  (high load)

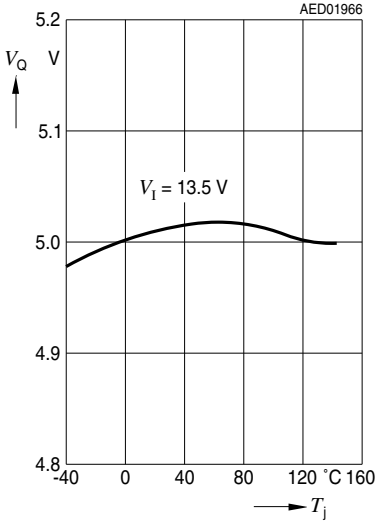


Current Consumption  $I_q$  versus Output Current  $I_Q$  (low load)

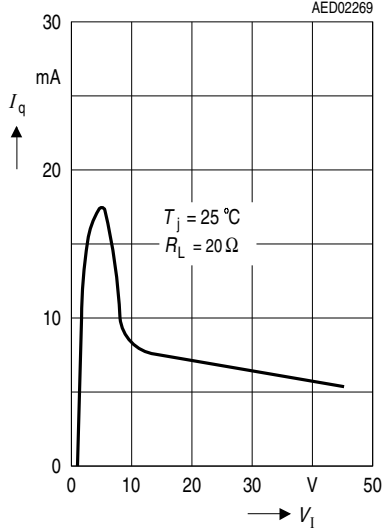


Typical Performance Characteristics (V50)

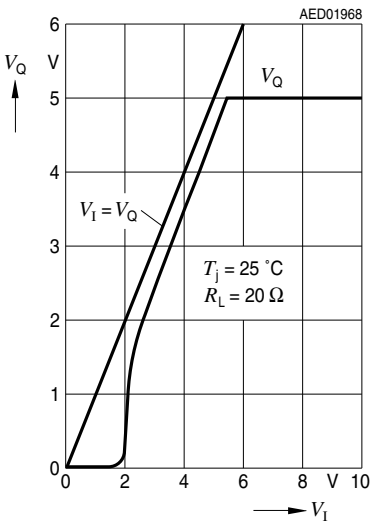
Output Voltage  $V_Q$  versus Junction Temperature  $T_j$



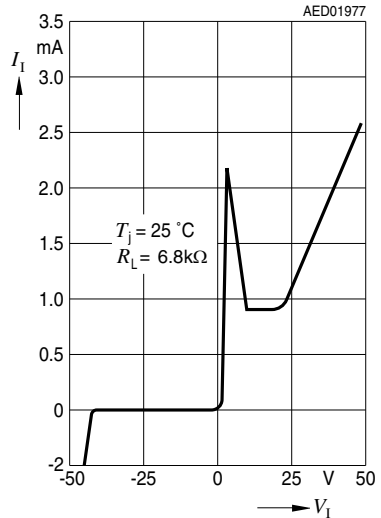
Current Consumption  $I_q$  versus Input Voltage  $V_I$



Output Voltage  $V_Q$  versus Input Voltage  $V_I$

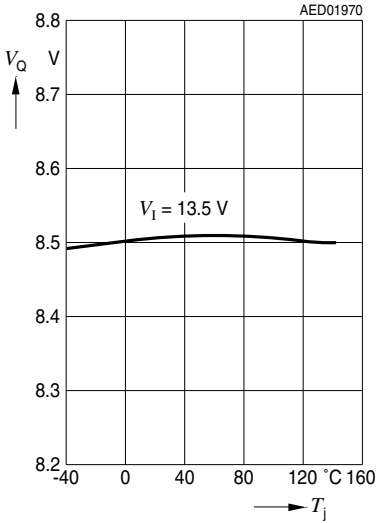


Input Current  $I_I$  versus Input Voltage  $V_I$

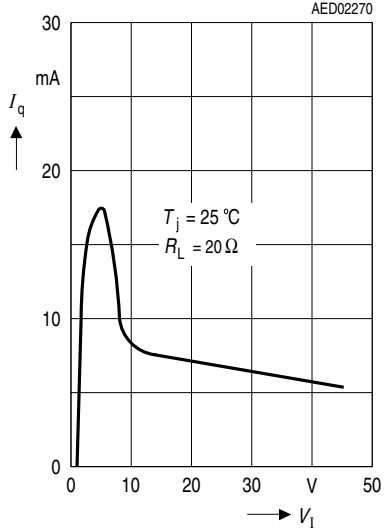


Typical Performance Characteristics for V85

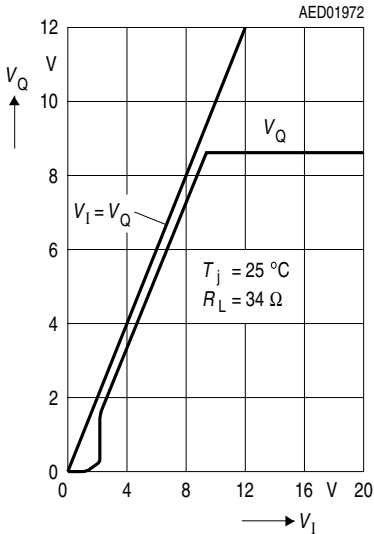
Output Voltage  $V_Q$  versus Junction Temperature  $T_j$



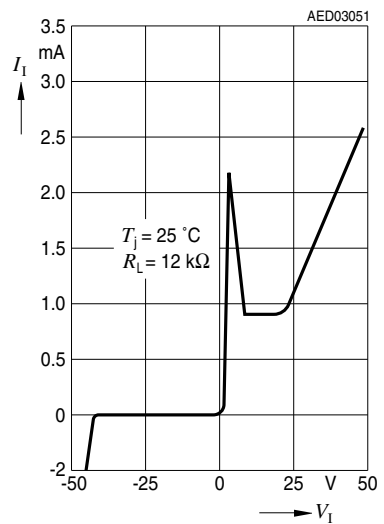
Current Consumption  $I_q$  versus Input Voltage  $V_i$



Output Voltage  $V_Q$  versus Input Voltage  $V_i$

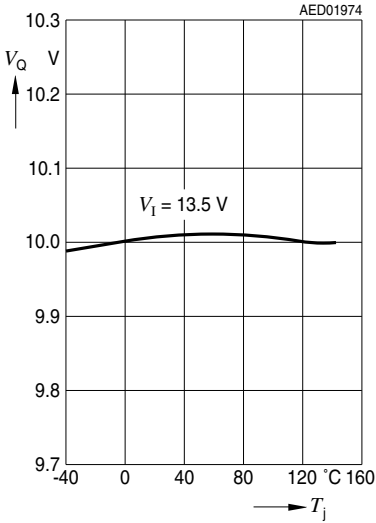


Input Current  $I_i$  versus Input Voltage  $V_i$

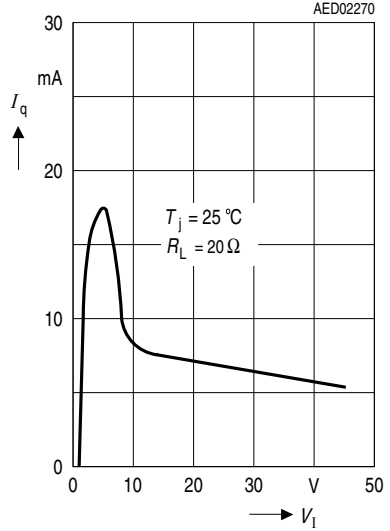


Typical Performance Characteristics for V10

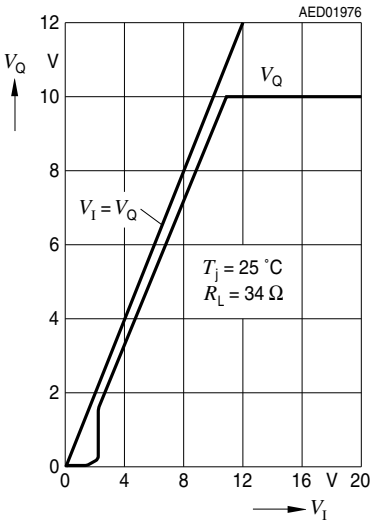
Output Voltage  $V_Q$  versus Junction Temperature  $T_j$



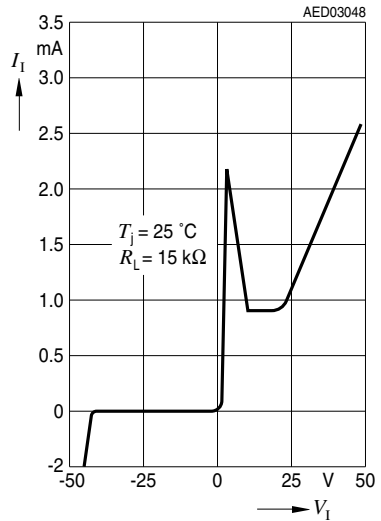
Current Consumption  $I_q$  versus Input Voltage  $V_I$



Output Voltage  $V_Q$  versus Input Voltage  $V_I$



Input Current  $I_I$  versus Input Voltage  $V_I$



Package Outlines

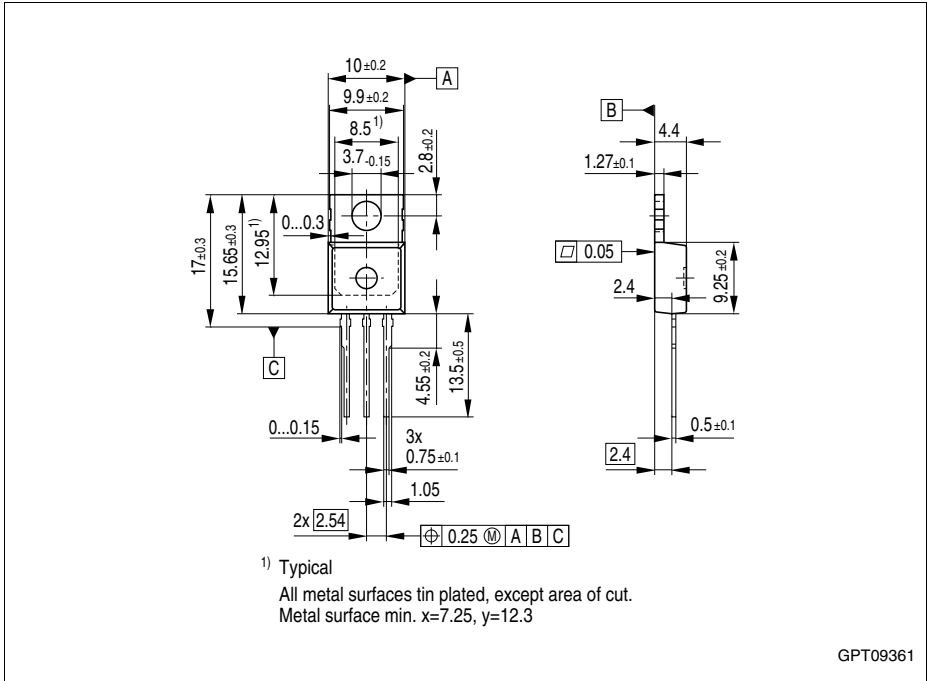


Figure 5 PG-TO220-3-1 (Plastic Transistor Single Outline)

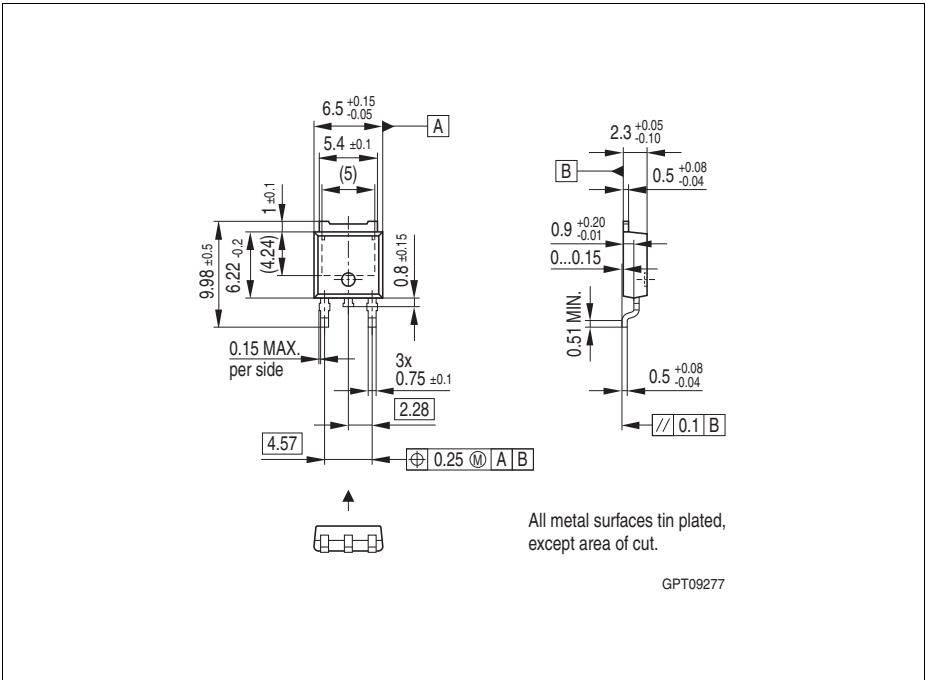
Green Product (RoHS-Compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products": <http://www.infineon.com/products>.

SMD = Surface Mounted Device

Dimensions in mm



**Figure 6 PG-TO252-3-11 (Plastic Transistor Single Outline)**

**Green Product (RoHS-Compliant)**

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SMD = Surface Mounted Device

Dimensions in mm



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**TLE 4274****Revision History:**                      **2011-01-20**    Rev. 1.7

Previous Version:                      1.5

<b>Page</b>	<b>Subjects (major changes since last revision)</b>
general	Updated Infineon logo
#1	Added "AEC" and "Green" logo
#1	Added "Green Product" and "AEC qualified" to the feature list
#1	Updated Package Names to "PG-xxx"
general	Removed leadframe variant "P-TO-252-1"
#12, #13, #14	Added "Green Product" remark
#16	Disclaimer Update
#17	Updated Package Outlines (added TAB potential)

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